

Bipolar Transistors Silicon PNP Epitaxial Type

# **TTA500**

### 1. Applications

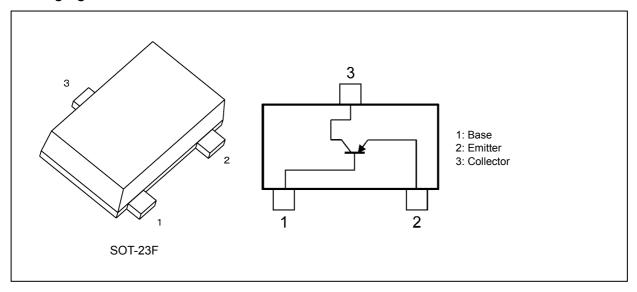
- · High-Speed Switching
- · DC-DC Converters

#### 2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) High DC current gain:  $h_{FE} = 200$  to 500 ( $I_{C} = -0.1$  A)
- (3) Low collector-emitter saturation voltage:  $V_{CE(sat)} = -0.2 \text{ V (max)}$
- (4) High-speed switching:  $t_f = 70 \text{ ns (typ.)}$

Note 1: For detail information, please contact our sales.

### 3. Packaging and Internal Circuit



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# 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics			Symbol	Rating	Unit
Collector-base voltage			V <sub>CBO</sub>	-50	V
Collector-emitter voltage	,	,	V <sub>CEO</sub>	-50	V
Emitter-base voltage			V <sub>EBO</sub>	-7	٧
Collector current (DC)		(Note 1)	Ic	-1.0	Α
Collector current (pulsed)	,	(Note 1)	I <sub>CP</sub>	-2.0	Α
Base current			I <sub>B</sub>	-100	mA
Collector power dissipation	DC	(Note 2)	Pc	1	W
Collector power dissipation	(t = 1 s)	(Note 2)	Pc	1.3	W
Junction temperature			Tj	150	℃
Storage temperature			T <sub>stg</sub>	- 55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Ensure that the channel temperature does not exceed 150 °C.
- Note 2: Device mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm ,Cu pad: 645 mm<sup>2</sup>)



### 5. Electrical Characteristics

# 5.1. Static Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB}$ = -50 V , $I_E$ = 0 mA	_	_	-100	nA
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = -7 \text{ V, } I_{C} = 0 \text{ mA}$	_	_	-100	nA
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	$I_{C}$ = -10 mA, $I_{B}$ = 0 mA	-50			V
DC current gain	h <sub>FE</sub> (1)	$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$	200		500	_
	h <sub>FE</sub> (2)	$V_{CE} = -2 \text{ V}, I_{C} = -0.3 \text{ A}$	125	_	_	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -0.3 \text{ A}, I_B = -10 \text{ mA}$	_	_	-0.2	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = -0.3 \text{ A}, I_B = -10 \text{ mA}$	_		-1.1	V

# 5.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_{E} = 0 \text{ mA},$ f = 1 MHz	_	8		pF
Switching time (rise time)	t <sub>r</sub>	See Figure 5.2.1	_	60	_	ns
Switching time (storage time)	t <sub>stg</sub>	$V_{cc} \approx -30 \text{ V, } R_L = 100 \Omega,$ $I_{B1} = 10 \text{ mA, } I_{B2} = 10 \text{ mA}$	_	280		ns
Switching time (fall time)	t <sub>f</sub>		_	70	_	ns

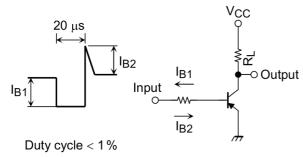
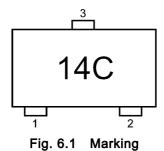


Fig. 5.2.1 Switching Time Test Circuit

## 6. Marking



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### 7. Characteristics Curves (Note)

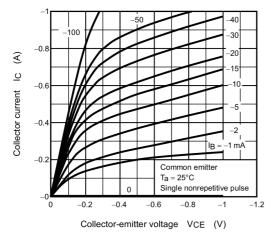


Fig. 7.1 I<sub>C</sub> - V<sub>CE</sub>

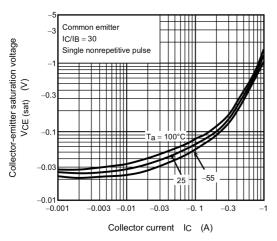


Fig. 7.3 V<sub>CE(sat)</sub> - I<sub>C</sub>

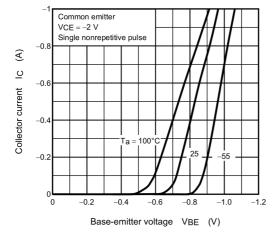


Fig. 7.5 I<sub>C</sub> - V<sub>BE</sub>

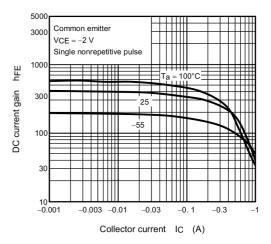


Fig. 7.2 h<sub>FE</sub> - I<sub>C</sub>

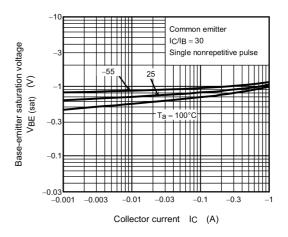


Fig. 7.4 V<sub>BE(sat)</sub> - I<sub>C</sub>



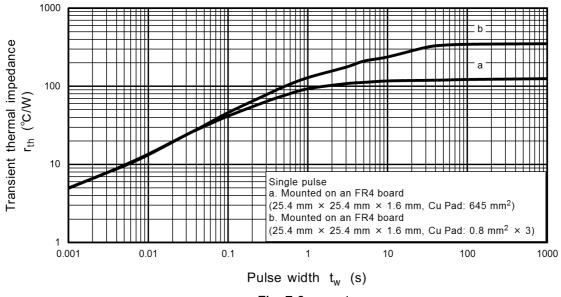


Fig. 7.6 rth - tw

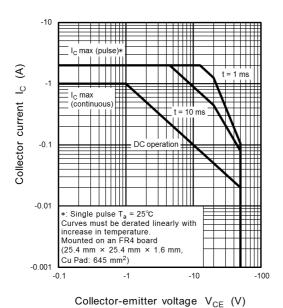


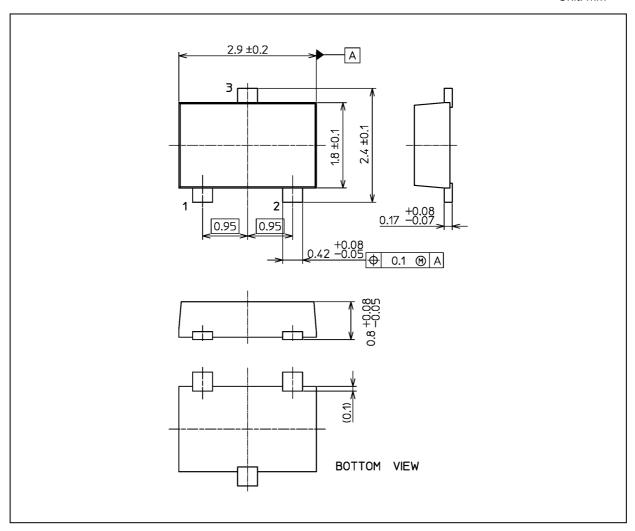
Fig. 7.7 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 0.011 g (typ.)

	Package Name(s)
Nickname: SOT-23F	



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